

5.70*3.00 SMD

A-5730BUW-S

Features

- Single color.
- Viewing angle:120 deg
- The materials of the LED dice is InGaN
- RoHS compliant lead-free soldering compatible

Applications

- Optical indicator
- Indoor display
- Interior automotive lighting
- Backlight for LCD, switch and Symbol, display
- Light pipe application
- General use

Ordering Information

PART NO.	SIZE	Dice	Lens Type
A-5730BUW-S	5.70*3.00*0.90mm	WHITE (InGaN)	Yellow Diffused

Luminous intensity(mcd)		Luminous flux(lm)	
Min.	Typ.	Min.	Typ.
16500	18000	-	53

Maximum Ratings

Parameter	Symbol	Value	Unit
Operating temperature	T _{OP}	-20 ~ 85	°C
Storage temperature	T _{STG}	-35 ~ 85	°C
Forward current (T _A =25 °C)	I _F	180	mA
Pulse Forward Current	I _{FP}	1000	mA
Reverse voltage (T _A =25 °C)	V _R	5	V
Electrostatic Discharge (HBM)	ESD	2000	V
Power Dissipation	Pd	-	mW

*¹ at 1/10 Duty Cycle

Electrical / Optical Characteristics

(T_A = 25 °C)

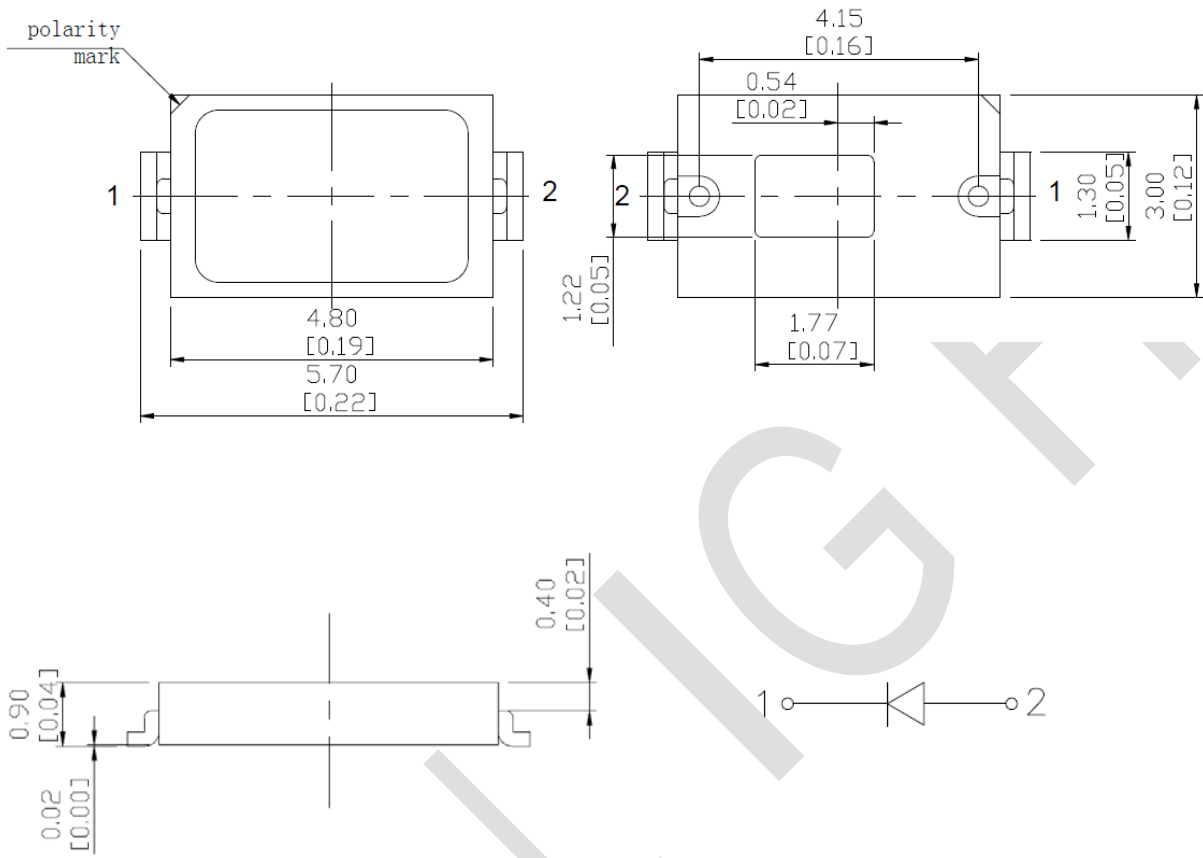
Parameter	Symbol	Value	Unit
Viewing angle at 50% I _F = 20mA	(Typ.) 2θ_{1/2}	120	degree
Forward voltage I _F = 20mA	(Min.) V_F	2.90	V
	(Typ.) V_F	3.20	V
	(Max.) V_F	3.50	V
Reverse current V _R = 5V	(Max.) I_R	10	μA
Color Rending Index V _R = 5V	(Min.) -	70	-
Color Temperature I _F = 20mA	(Typ.) T_c	6500	K

Luminous Intensity and Luminous Flux

(T_A = 25 °C & I_F = 20 mA)

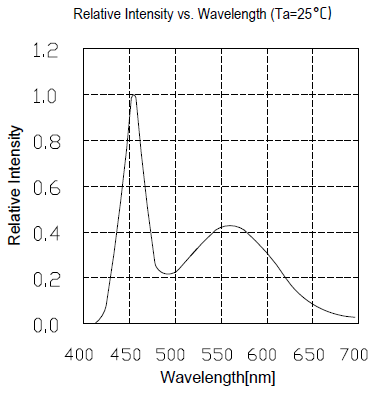
Luminous intensity(mcd)		Luminous flux(lm)	
Min.	Typ.	Min.	Typ.
16500	18000	-	53

Package Dimensions

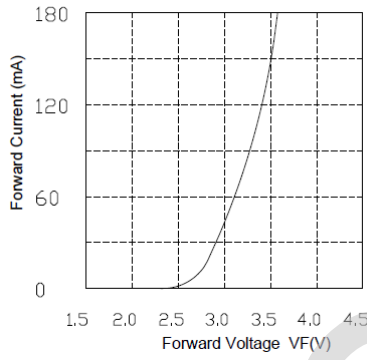


Electrical/Optical Characteristic

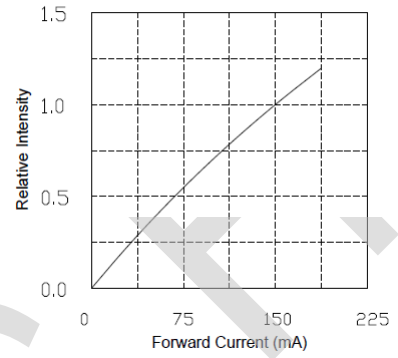
Spectral Distribution



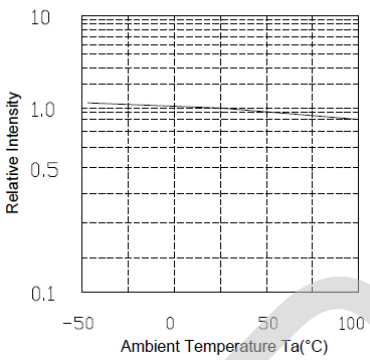
Forward Current vs. Forward Voltage (Ta=25°C)



Relative Intensity vs. Forward Current (Ta=25°C)

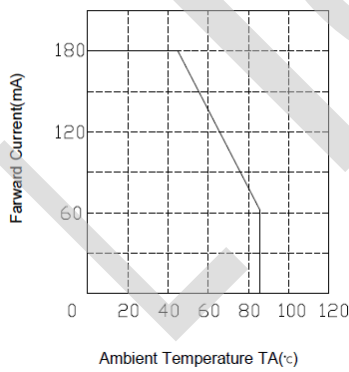


Relative Intensity vs. Ambient Temperature



Derating

Maximum Forward Current vs. Ambient Temperature



Forward Current vs. Chromaticity (Ta=25°C)

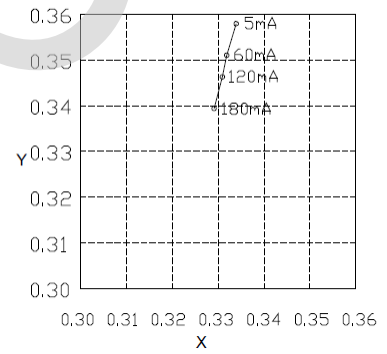
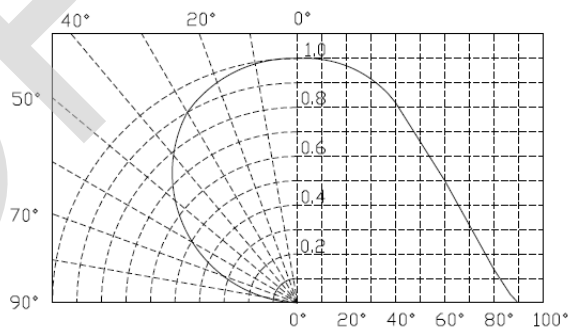
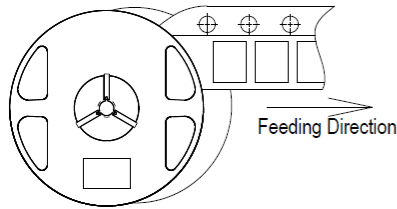


Diagram characteristics of radiation

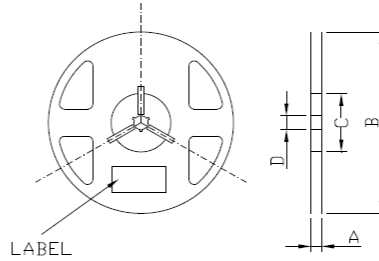


Package Outline Dimensions

● Feeding Direction

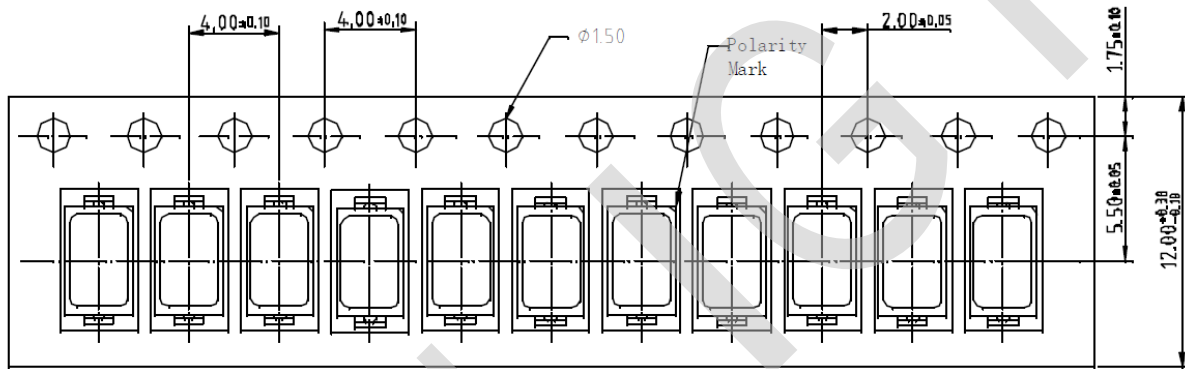


● Dimensions of Reel (Unit: mm)

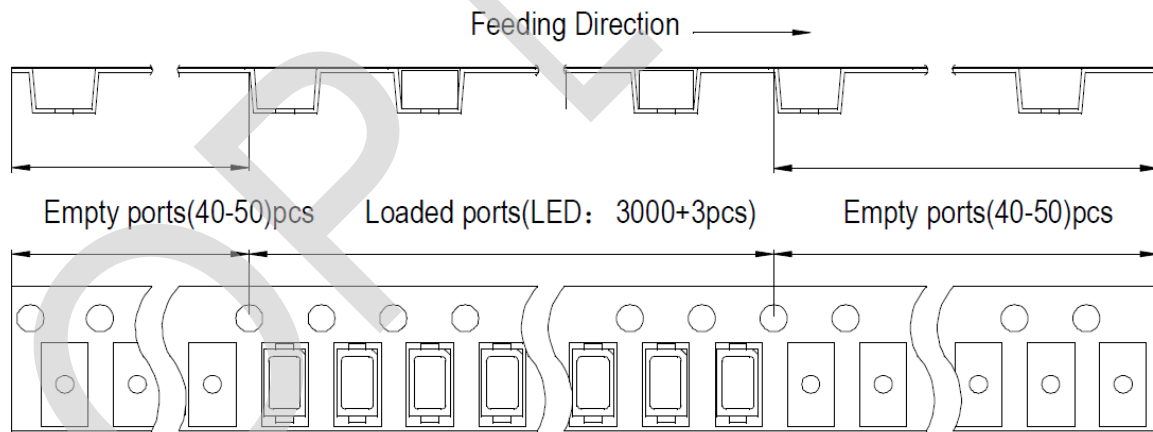


A	13.6 ± 0.1mm
B	179 ± 1mm
C	58 ± 1mm
D	13.5 ± 0.5mm

● Dimensions of Tape (Unit: mm)



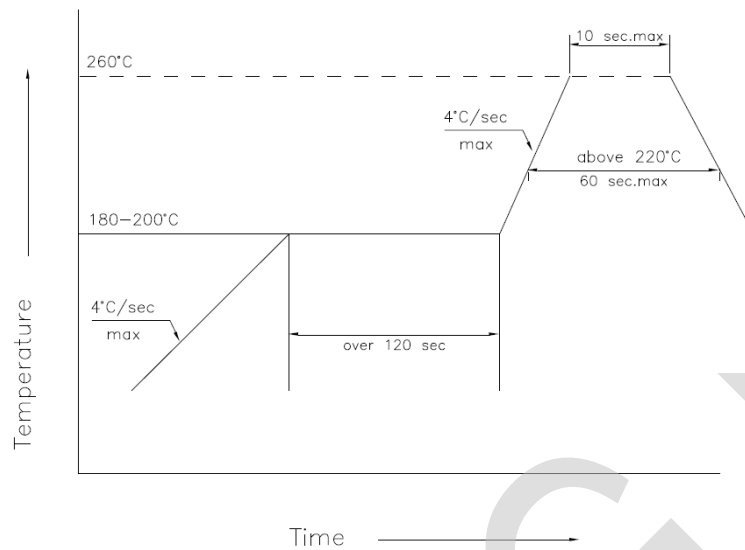
● Arrangement of tape:



NOTES:

1. Empty component pockets are sealed with top cover tape;
2. The maximum number of missing lamps is two;
3. The cathode is oriented towards the tape sprocket hole in accordance with ANSI/EIA RS-481 specifications.
4. 3,000 pcs/ Reel.

SMT Reflow Soldering Instructions



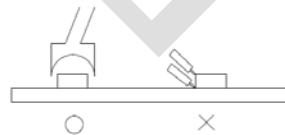
- 1.Reflow soldering should not be done more than two times
- 2.When soldering , do not put stress on the LEDs during heating

Soldering iron

- 1.When hand soldering, the temperature of the iron must less than 300°C for 3 seconds
- 2.The hand solder should be done only one times

Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of LEDs will or will not be damaged by repairing.



Cautions

The encapsulated material of the LEDs is silicone. Therefore the LEDs have a soft surface on the top of package. The pressure to the top surface will be influence to the reliability of the LEDs. Precautions should be taken to avoid the strong pressure on the encapsulated part. So when use the picking up nozzle, the pressure on the silicone resin should be proper.